<b>PCN Number:</b> 20190411000 <b>PCN Date:</b> April 22, 2019				19		
Title: Datasheet for ISO1540, ISO1541						
<b>Customer Contact:</b>	PCN Manager	Manager		De	pt:	Quality Services
Change Type:						
Assembly Site	·	Design			Wafei	r Bump Site
Assembly Process		Data Sheet			Wafer Bump Material	
Assembly Materials	5	Part number change			Wafer Bump Process	
Mechanical Specification		Test Site				r Fab Site
Packing/Shipping/Labeling		Test Process		$\perp$	Wafer Fab Materials	
					Wafer Fab Process	
Notification Details						
Description of Change: Texas Instruments Incorporated is announcing an information only notification.						
The product datasheet(s) is being updated as summarized below. The following change history provides further details.  ISO1540, ISO1541						
				S	LLSEB6E -	JULY 2012-REVISED APRIL 2019
Changes from Revision D (	December 2016) 1	to Revision E				Page
<ul> <li>Changed VDE Standard name From: DIN V VDE V 0884-10 (VDE V 0884-10): 2006-12 To: DIN VDE V 0884- 11:2017-01 in Features</li> </ul>						
Changed Features bullet From: CSA Component Acceptance Notice 5A, IEC 60950-1 and IEC 61010-1 End Equipment Standards To: CSA approval per IEC 60950-1 and IEC 62368-1 end equipment standards						
· Changed both bypass ca	ated Certifications to pacitors From: 10	table μF To: 0.1 μF ir	n Figure 31. Even t	though la	arger cap	pacitors can be used,
<ul> <li>0.1 μF is the minimum recommended bypass capacitor size.</li> <li>Changed both bypass capacitors From: 10 μF To: 0.1 μF in Figure 32. Even though larger capacitors can be used, 0.1 μF is the minimum recommended bypass capacitor size.</li> </ul>						
The datasheet number will be changing.						
Device Family			Change	From:		Change To:
ISO1540, ISO1541			SLLSEB6	SLLSEB6D		SLLSEB6E
These changes may be reviewed at the datasheet links provided.  http://www.ti.com/product/ISO1540						
Reason for Change:						
To accurately reflect device characteristics.						
<u>'</u>			uality as Dali	abilit	. (	tivo / pogativa):
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):  No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.						
Changes to product identification resulting from this PCN:						
None.						
Product Affected:	T = = =		T = = =			
ISO1540D	ISO1540D	R	ISO1541D			ISO1541DR

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
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